

Description

The ZXMP3A13F uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

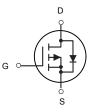


General Features

 $V_{DS} = -30V, I_{D} = -4.1A$ $R_{DS(ON)}$ <56m Ω @ V_{GS} =10V

Application

High power and current handing capability Lead free product is acquired Surface mount package PWM applications Load switch Power management



P-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
ZXMP3A13F	SOT-23	HXY MOSFET	3000

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
VDS	Drain-Source Voltage	-30	V
V _G s	Gate-Source Voltage	±20	V
I _D	Drain Current-Continuous	-4.1	А
Ірм	Drain Current-Pulsed (Note 1)	-13	А
P _D	Maximum Power Dissipation	1.32	W
TJ,Tstg	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$
Rеja	Thermal Resistance, Junction-to-Ambient (Note 2)	125	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-30			V	
△BV _{DSS} /△T _J	BVDSS Temperature Coefficient	Reference to 25°C , I _D =-1mA		-0.02		V/°C	
Г.	Static Drain Source On Decistance?	V _{GS} =-10V , I _D =-3A		48	56	mO	
RDS(ON)	Static Drain-Source On-Resistance ² $V_{GS}=-4.5V , I_{D}=-1.5A$		78	90	mΩ		
V _{GS(th)}	Gate Threshold Voltage	Vgs=Vps . Ip =-250uA	-1.2	-1.5	-2.5	V	
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	VGS-VDS , ID250UA		4.32		mV/°C	
	Danier Courses I and an a Course of	V _{DS} =-24V , V _{GS} =0V , T _J =25°C			-1	uA	
I_{DSS}	Drain-Source Leakage Current	V _{DS} =-24V , V _{GS} =0V , T _J =55°C			-5		
Igss	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA	
gfs	Forward Transconductance	V_{DS} =-5 V , I_{D} =-3 A		4.8		S	
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		24	48	Ω	
Q_g	Total Gate Charge (-4.5V)			5.22	7.3		
Qgs	Gate-Source Charge	V _{DS} =-20V , V _{GS} =-4.5V , I _D =-3A		1.25	1.8	nC	
Q _{gd}	Gate-Drain Charge			2.3	3.2		
T _{d(on)}	Turn-On Delay Time			18.4	37		
Tr	Rise Time	V_{DD} =-15V , V_{GS} =-10V , R_{G} =3.3 Ω		11.4	21	ns	
$T_{d(off)}$	Turn-Off Delay Time	I _D =-1A		39.4	79		
T _f	Fall Time			5.2	10.4		
Ciss	Input Capacitance			463	650		
Coss	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		82	115	pF	
Crss	Reverse Transfer Capacitance			68	95		
Is	Continuous Source Current ^{1,4}	Vo=Vo=0V Force Current			-3.2	Α	
Ism	Pulsed Source Current ^{2,4}	──V _G =V _D =0V , Force Current			-13	Α	
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , T _J =25°C			-1	V	

Note:

^{1.} The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

^{2.}The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

^{3.}The power dissipation is limited by 150 $^{\circ}$ C junction temperature

^{4.} The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

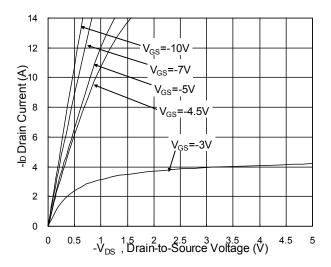


Fig.1 Typical Output Characteristics

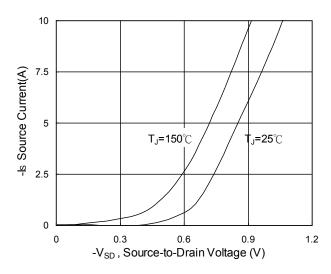


Fig.3 Source Drain Forward Characteristics

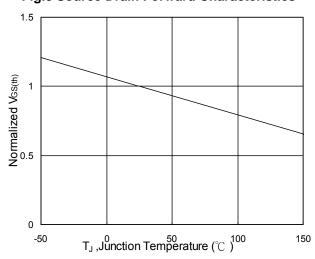


Fig.5 Normalized V_{GS(th)} vs. T_J

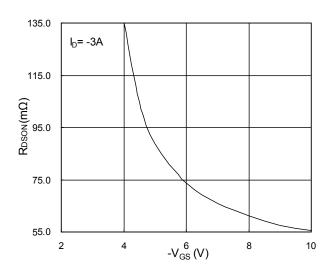


Fig.2 On-Resistance vs. G-S Voltage

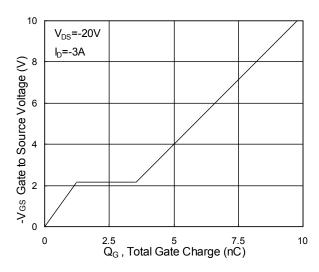


Fig.4 Gate-Charge Characteristics

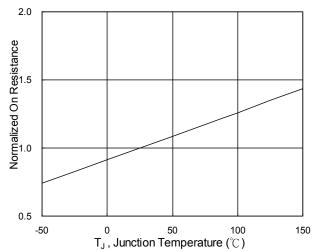
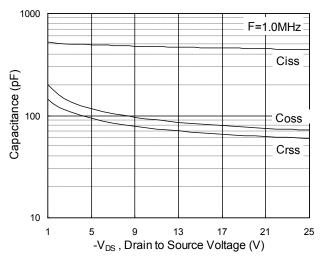


Fig.6 Normalized R_{DSON} vs. T_J





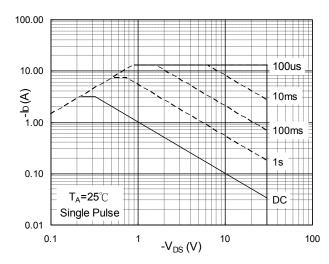


Fig.7 Capacitance

Fig.8 Safe Operating Area

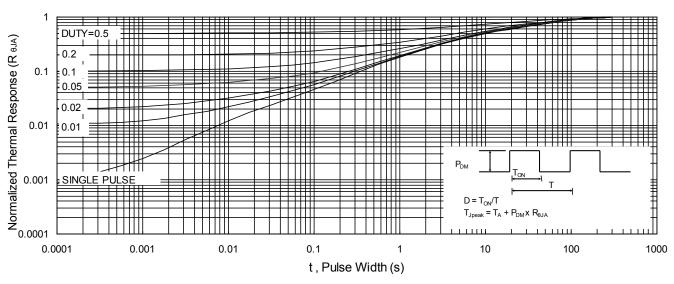
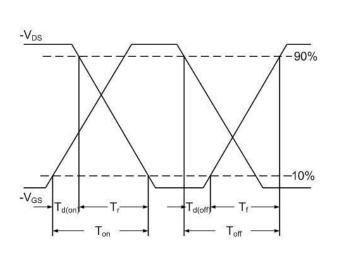


Fig.9 Normalized Maximum Transient Thermal Impedance



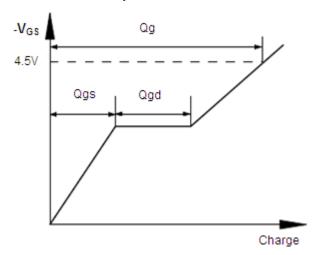
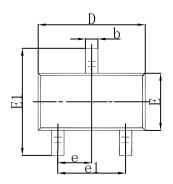


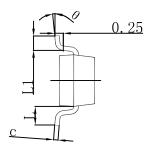
Fig.10 Switching Time Waveform

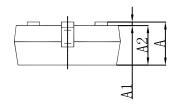
Fig.11 Gate Charge Waveform



SOT-23 Package Outline Dimensions

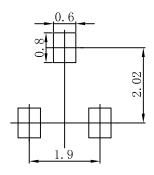






Cumhal	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

SOT-23 Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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